

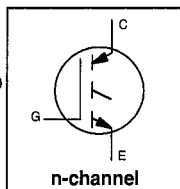
**INSULATED GATE BIPOLAR TRANSISTOR**

 Short Circuit Rated  
 Fast IGBT

**Features**

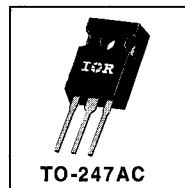
- Short circuit rated - 10 $\mu$ s @ 125°C,  $V_{GE} = 15V$
- Switching-loss rating includes all "tail" losses
- Optimized for medium operating frequency (1 to 10kHz)

See Figure 1 for Current vs. Frequency curve


 $V_{CES} = 600V$   
 $V_{CE(sat)} \leq 2.6V$   
 @  $V_{GE} = 15V, I_C = 51A$ 
**Description**

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.

These new short circuit rated devices are especially suited for motor control and other applications requiring short circuit withstand capability.


**TO-247AC**
**Absolute Maximum Ratings**

|                           | Parameter                                        | Max.                              | Units      |
|---------------------------|--------------------------------------------------|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 70*                               | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 51                                |            |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 170                               |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 170                               |            |
| $t_{sc}$                  | Short Circuit Withstand Time                     | 10                                | $\mu$ s    |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$                          | V          |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③               | 25                                | mJ         |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 280                               | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 110                               |            |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to +150                       | $^\circ C$ |
| $T_{STG}$                 | Soldering Temperature, for 10 sec.               | 300 (0.063 in. (1.6mm) from case) |            |
|                           | Mounting torque, 6-32 or M3 screw.               | 10 lbf•in (1.1N•m)                |            |

**Thermal Resistance**

|                 | Parameter                                 | Min.  | Typ.     | Max.  | Units        |
|-----------------|-------------------------------------------|-------|----------|-------|--------------|
| $R_{\theta JC}$ | Junction-to-Case                          | ----- | -----    | 0.45  | $^\circ C/W$ |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | ----- | 0.24     | ----- |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | ----- | -----    | 40    |              |
| Wt              | Weight                                    | ----- | 6 (0.21) | ----- | g (oz)       |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

|                                  | Parameter                                | Min. | Typ. | Max.      | Units   | Conditions                                                                            |
|----------------------------------|------------------------------------------|------|------|-----------|---------|---------------------------------------------------------------------------------------|
| $V_{BR(ICES)}$                   | Collector-to-Emitter Breakdown Voltage   | 600  | —    | —         | V       | $V_{GE} = 0V, I_C = 250\mu A$                                                         |
| $V_{BR(ICES)}$                   | Emitter-to-Collector Breakdown Voltage ④ | 20   | —    | —         | V       | $V_{GE} = 0V, I_C = 1.0A$                                                             |
| $\Delta V_{BR(ICES)}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 0.62 | —         | V/°C    | $V_{GE} = 0V, I_C = 2.0mA$                                                            |
| $V_{CE(ON)}$                     | Collector-to-Emitter Saturation Voltage  | —    | 1.7  | 2.6       | V       | $V_{GE} = 15V$<br>See Fig. 2, 5                                                       |
|                                  |                                          | —    | 2.2  | —         |         |                                                                                       |
|                                  |                                          | —    | 2.0  | —         |         |                                                                                       |
| $V_{GE(th)}$                     | Gate Threshold Voltage                   | 3.0  | —    | 5.5       | mV/°C   | $I_C = 51A$<br>$I_C = 87A$<br>$I_C = 51A, T_J = 150^\circ\text{C}$                    |
| $\Delta V_{GE(th)}/\Delta T_J$   | Temperature Coeff. of Threshold Voltage  | —    | -13  | —         |         |                                                                                       |
| $g_{fs}$                         | Forward Transconductance ⑤               | 22   | 33   | —         |         |                                                                                       |
| $I_{CES}$                        | Zero Gate Voltage Collector Current      | —    | —    | 250       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 600V$<br>$V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
|                                  |                                          | —    | —    | 2000      |         |                                                                                       |
| $I_{GES}$                        | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA      | $V_{GE} = \pm 20V$                                                                    |

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

|              | Parameter                         | Min. | Typ. | Max. | Units   | Conditions                                                                                                                                    |
|--------------|-----------------------------------|------|------|------|---------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| $Q_g$        | Total Gate Charge (turn-on)       | —    | 110  | 160  | nC      | $I_C = 51A$<br>$V_{CC} = 400V$<br>$V_{GE} = 15V$<br>See Fig. 8                                                                                |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   | —    | 27   | 42   |         |                                                                                                                                               |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) | —    | 43   | 65   |         |                                                                                                                                               |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 40   | —    | ns      | $I_C = 51A, V_{CC} = 480V$<br>$V_{GE} = 15V, R_G = 3.3\Omega$<br>Energy losses include "tail"<br>See Fig. 9, 10, 11, 14                       |
| $t_r$        | Rise Time                         | —    | 41   | —    |         |                                                                                                                                               |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 380  | 560  |         |                                                                                                                                               |
| $t_f$        | Fall Time                         | —    | 210  | 310  | mJ      | $V_{CC} = 360V, T_J = 125^\circ\text{C}$<br>$V_{GE} = 15V, R_G = 3.3\Omega, V_{CPK} < 500V$                                                   |
| $E_{on}$     | Turn-On Switching Loss            | —    | 1.5  | —    |         |                                                                                                                                               |
| $E_{off}$    | Turn-Off Switching Loss           | —    | 4.9  | —    |         |                                                                                                                                               |
| $E_{ts}$     | Total Switching Loss              | —    | 6.4  | 9.5  | $\mu s$ | $T_J = 150^\circ\text{C}$<br>$I_C = 51A, V_{CC} = 480V$<br>$V_{GE} = 15V, R_G = 3.3\Omega$<br>Energy losses include "tail"<br>See Fig. 10, 14 |
| $t_{sc}$     | Short Circuit Withstand Time      | 10   | —    | —    |         |                                                                                                                                               |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 38   | —    | ns      | $V_{GE} = 0V$<br>$V_{CC} = 30V$<br>See Fig. 7                                                                                                 |
| $t_r$        | Rise Time                         | —    | 44   | —    |         |                                                                                                                                               |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 680  | —    |         |                                                                                                                                               |
| $t_f$        | Fall Time                         | —    | 410  | —    | mJ      | Measured 5mm from package                                                                                                                     |
| $E_{is}$     | Total Switching Loss              | —    | 12   | —    |         |                                                                                                                                               |
| $L_E$        | Internal Emitter Inductance       | —    | 13   | —    | nH      |                                                                                                                                               |
| $C_{ies}$    | Input Capacitance                 | —    | 4400 | —    | pF      | $f = 1.0MHz$                                                                                                                                  |
| $C_{oss}$    | Output Capacitance                | —    | 340  | —    |         |                                                                                                                                               |
| $C_{res}$    | Reverse Transfer Capacitance      | —    | 33   | —    |         |                                                                                                                                               |

**Notes:**

① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. (See Fig. 13b)

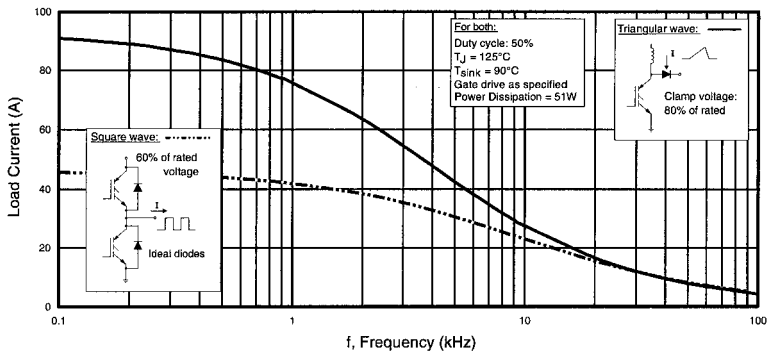
② Repetitive rating; pulse width limited by maximum junction temperature.

③ Pulse width 5.0 $\mu s$ , single shot.

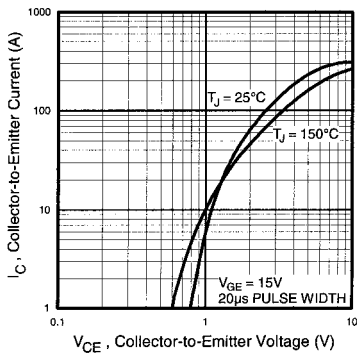
④  $V_{CC} = 80\%(V_{CES})$ ,  $V_{GE} = 20V$ ,  $L = 10\mu H$ ,  $R_G = 3.3\Omega$ . (See Fig. 13a)

⑤ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .

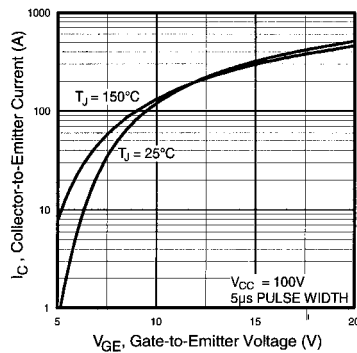
\* Current Limited by the Package, (Die Current = 87A).



**Fig. 1 - Typical Load Current vs. Frequency**  
(For square wave,  $I = I_{\text{RMS}}$  of fundamental; for triangular wave,  $I = I_{\text{PK}}$ )



**Fig. 2 - Typical Output Characteristics**



**Fig. 3 - Typical Transfer Characteristics**

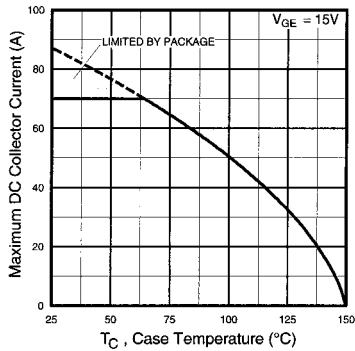


Fig. 4 - Maximum Collector Current vs. Case Temperature

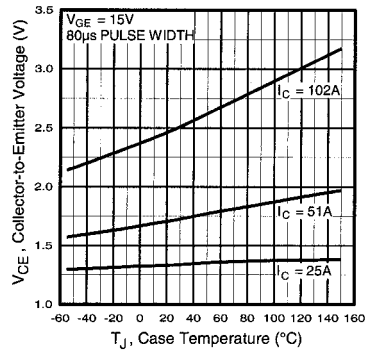


Fig. 5 - Collector-to-Emitter Voltage vs. Case Temperature

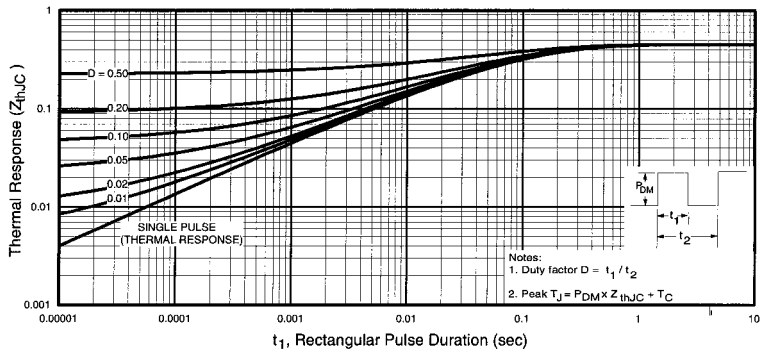
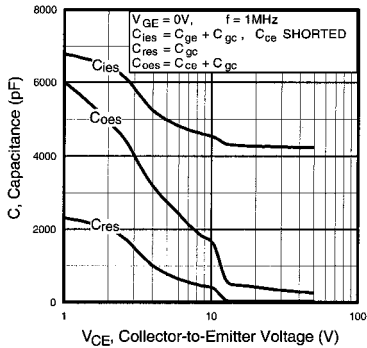
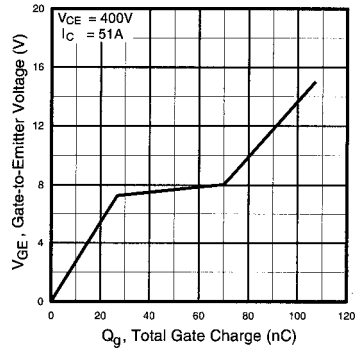


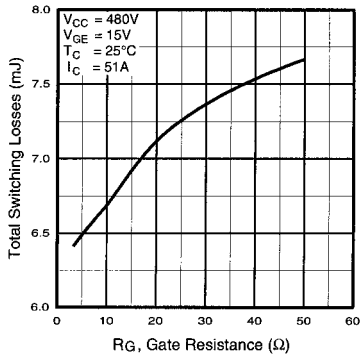
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



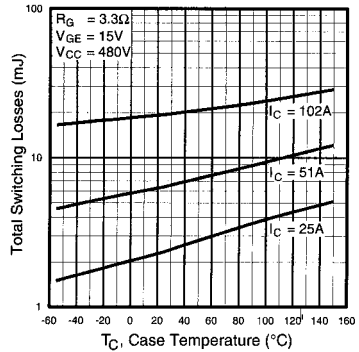
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



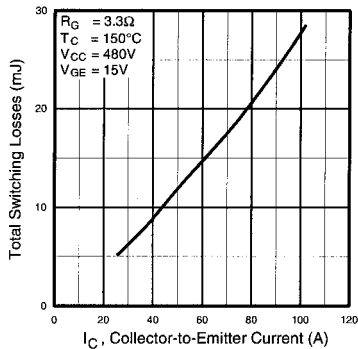
**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**



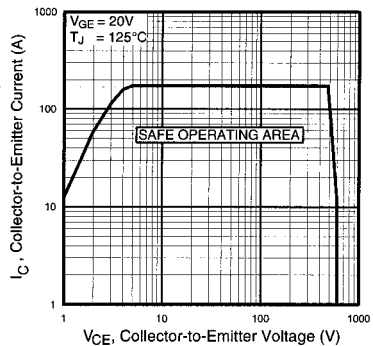
**Fig. 9 - Typical Switching Losses vs. Gate Resistance**



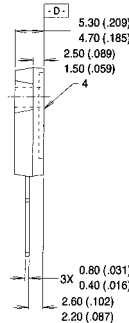
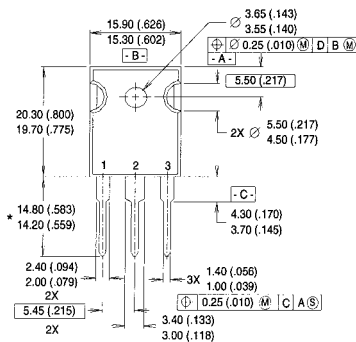
**Fig. 10 - Typical Switching Losses vs. Case Temperature**



**Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current**



**Fig. 12 - Turn-Off SOA**



## NOTES:

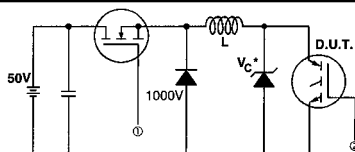
- 1 DIMENSIONS & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: INCH.
- 3 DIMENSIONS ARE SHOWN MILLIMETERS (INCHES).
- 4 CONFORMS TO JEDEC OUTLINE TO-247AC.

## LEAD ASSIGNMENTS

- 1 - GATE
- 2 - COLLECTOR
- 3 - EMITTER
- 4 - COLLECTOR

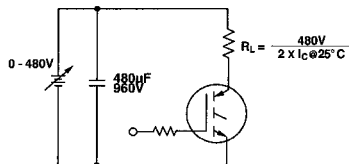
\* LONGER LEADED (20mm) VERSION AVAILABLE (TO-247AD) TO ORDER ADD "E" SUFFIX TO PART NUMBER

**CONFORMS TO JEDEC OUTLINE TO-247AC (TO-3P)**  
Dimensions in Millimeters and (Inches)

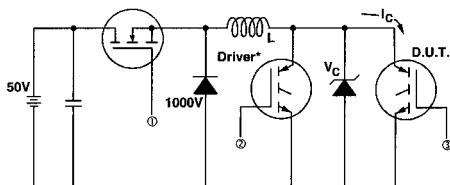


- \* Driver same type as D.U.T.;  $V_c = 80\%$  of  $V_{ce(max)}$
- \* Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated  $I_d$ .

**Fig. 13a - Clamped Inductive Load Test Circuit**

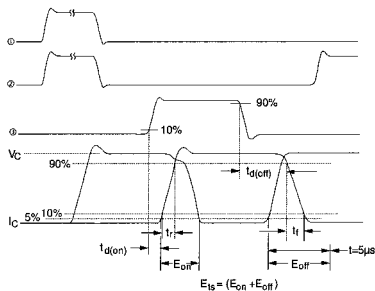


**Fig. 13b - Pulsed Collector  
Current Test Circuit**



**Fig. 14a - Switching Loss Test Circuit**

\* Driver same type as D.U.T., VC = 480V



**Fig. 14b - Switching Loss Waveforms**

# International Rectifier

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*Data and specifications subject to change without notice. 4/95*